OM13086

Product Brief

LPC43S67 & A70CM Cloud Connectivity

Rev 1.2 - 10th November 2015

The LPCXpresso43S67 & A70CM Cloud Connectivity Kit provides a complete hardware and software platform for developers to evaluate and prototype with the LPC43S6x processor family in cloud connected applications based on IEEE802.11b/g wireless connectivity.



Feature summary

- LPCXpresso43S67 (OM13084) with LPC43S67 triple-core (M4F and dual M0) MCU running at up to 204MHz
- Zentri IEEE 802.11b/g SD card (featuring Murata SN8000 module)
- Fully supported by ZentriOS
- High Speed USB based debug probe with CMSIS-DAP and SEGGER J-Link OB protocol options
- NXP A7001CM Secure Element
- NTAG plug-in card featuring NXP NT3H1201W0FHK Forum Type 2 Tag with field detection pin and I2C
- LPC General Purpose Shield (OM13082) with Ethernet (RJ45), LCD screen and user LEDs, accelerometer, gyroscope, temperature sensor, potentiometer, joystick and SD card slot
- High speed USB A/B connector for host or slave operation
- 8Mb Macronix guad SPI flash
- FTDI UART connector and built-in UART to USB bridge options
- USB cables included

Overview

The CC Kit combines an LPCXpresso43S67 board, which also includes an A7001CM Secure Element, with a Zentri-designed, IEEE802.11b/g radio featuring the Murata SN8000 industrial-grade module, to provide a high performance MCU platform for application development.

The LPC General Purpose Shield also included in the Kit provides access to Ethernet connectivity along with several sensing devices/inputs and a convenient LCD display. In addition to on-board sensors, the Shield also provides easy access to terminal blocks for CAN bus analog inputs.

© NXP B.V. 2015.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 19th January 2015

OM13086

Product Brief

LPC43S67 & A70CM Cloud Connectivity

Rev 1.2 - 10th November 2015

The A7001CM Secure Microcontoller complements the LPC43S67 by offering tamper-resistant public and secret key encryption, along with the ability to store other sensitive system information.

The plug-in NTAG I²C board provides a convenient option for applications such as system commissioning/configuration and/or passing diagnostic information with an NFC-enabled device such as an Android phone.

ZentriOS

Zentri is radically changing the way product companies deliver secure mobile and cloud connected products that deliver rich connected experiences. Leveraging Zentri's Silicon-to-Cloud Connected Product Platform, customers get highly secure, robust, connected products to market in weeks instead of years. Delivering the connected experience product buyers expect, Zentri enables secure product authentication, provides license management, seamless and secure OTA software update, remote product diagnosis and analytics, and more. The heart of Zentri's platform is ZentriOS, a complete connected product operating system available as a licensable software solution or embedded into Zentri's line of Wi-Fi and Bluetooth LE modules. Cloud device management software is available as a service or as a connector for existing cloud partners. Users of the OM13086 kit can evaluate ZentriOS for free. See https://www.zentri.com/nxp for more information.

Development Tools

The Kit is supported by LPCXpresso IDE, available for free download at http://www.lpcware.com/lpcxpresso/download. The Zentri SDK, can be easily combined with the rich editing and debugging capabilities of the LPCXpresso IDE by installation of a free plugin. The LPCXpresso43S67's on-board Link2 probe provides full source code debugging capability without the need for any additional hardware.

In addition to ZentriOS (as mentioned above), NXP provides a full set of example for the LPCXpress43S67 and LPC General Purpose shield, available for free download at http://www.lpcware.com/lpcopen.

Board specifications

Recommended operating conditions: 0 to 70°C ambient

Weight: 91gm (3.2 ounces) excluding cables

Size: 220mm (max length) x 63mm, fully assembled, including connectors The LPCXpresso43S67 & A70CM Cloud Connectivity is RoHS compliant.

© NXP B.V. 2015.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 19th January 2015

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for nxp manufacturer:

Other Similar products are found below:

MC13211R2 PCA9518PW,112 LFSTBEB865X MC33399PEFR2 PCA9551PW,112 MC34825EPR2 CBTW28DD14AETJ PCF8583P MC68340AB16E MC8640DTVJ1250HE EVBCRTOUCH MC9S08PT16AVLC MC9S08PT8AVTG MC9S08SH32CTL MCF54415CMJ250 MCIMX6Q-SDB MCIMX6SX-SDB 74ALVC125BQ,115 74HC4050N 74HC4514N MK21FN1M0AVLQ12 MKV30F128VFM10 FRDM-K66F FRDM-KW40Z FRDM-MC-LVBLDC PESD18VF1BSFYL PMF63UNEX PSMN4R0-60YS,115 HEF4028BPN RAPPID-567XFSW MPC565MVR56 MPC574XG-176DS MPC8548VJAUJD MPC860PCVR66D4 BT137-600E BT137S-600D.115 BT138-600E.127 BT139X-600.127 BT258-600R.127 BUK7628-100A118 BUK765R0-100E.118 P5020NSE7VNB S12ZVML12EVBLIN SCC2692AC1N40 LPC1785FBD208K LPC2124FBD64/01 LS1020ASN7KQB LS1020AXN7HNB LS1020AXN7KQB LS1043ASE7PQA